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Effective March 1998

DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

(X) Original () Supplemental () Substitute () PCT () Design

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Title: **A METHOD OF MOUNTING A SEMICONDUCTOR LASER COMPONENT ON A SUBMOUNT**

of which is described and claimed in:

- (X) the attached specification, or
 () the specification in the application Serial No. _____ filed _____;
 and with amendments through _____ (if applicable), or
 () the specification in International Application No. , filed , and as amended on_ (if applicable).

I hereby state that I have reviewed and understand the content of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge my duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, ' 1.56.

I hereby claim priority benefits under Title 35, United States Code, ' 119 (and ' 172 if this application is for a Design) of any application(s) for patent or inventor's certificate listed below and have also identified below any application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:


COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
Japan	P 2001-354758	November 20, 2001	NO

I hereby claim the benefit under Title 35, United States Code ' 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code ' 112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, ' 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

APPLICATION SERIAL NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Warren M. Cheek, Jr., Reg. No. 33,367; Nils Pedersen, Reg. No. 33,145; Charles R. Watts, Reg. No. 33,142; and Michael S. Huppert, Reg. No. 40,268, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., as well as any other attorneys and agents associated with Customer No. 000513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith.

I hereby authorize the U.S. attorneys and agents named herein to accept and follow instructions from AOYAMA & PARTNERS, as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

Direct Correspondence to Customer No:  000513 PATENT TRADEMARK OFFICE	Direct Telephone Calls to: WENDEROTH, LIND & PONACK, L.L.P. 2033 "K" Street, N.W., Suite 800 Washington, D.C. 20006-1021 Phone: (202) 721-8200 Fax: (202) 721-8250
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Full Name of First Inventor	FAMILY NAME MOCHIDA	FIRST GIVEN NAME Atuhito	DECEASED
Residence & Citizenship	CITY Shizuoka-shi	STATE OR COUNTRY Shizuoka, Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 24-4, Ooiwahon-cho, Shizuoka-shi, Shizuoka	CITY Shizuoka	STATE OR COUNTRY Japan

Full Name of Second Inventor	FAMILY NAME INOUE	FIRST GIVEN NAME Hiroto	SECOND GIVEN NAME
Residence & Citizenship	CITY Hirakata-shi	STATE OR COUNTRY Osaka, Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 20-1-1021, Higashinakaburi 2-chome, Hirakata-shi, Osaka	CITY Osaka	STATE OR COUNTRY Japan

Full Name of Third Inventor	FAMILY NAME NAKAO	FIRST GIVEN NAME Suguru	SECOND GIVEN NAME
Residence & Citizenship	CITY Itami-shi	STATE OR COUNTRY Hyogo, Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 606, Sentoraru-Shinitami, 1-4-1, Misuzu-cho, Itami-shi, Hyogo	CITY Itami	STATE OR COUNTRY Japan

Full Name of Fourth Inventor	FAMILY NAME IWATA	FIRST GIVEN NAME Yukihiro	SECOND GIVEN NAME
Residence & Citizenship	CITY Ibaragi-shi	STATE OR COUNTRY Osaka, Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 7-9-401, Yamatedai 4-chome, Ibaragi-shi, Osaka	CITY Ibaragi	STATE OR COUNTRY Japan

Full Name of Fifth Inventor	FAMILY NAME TAKAMORI	FIRST GIVEN NAME Akira	SECOND GIVEN NAME
Residence & Citizenship	CITY Suita-shi	STATE OR COUNTRY Osaka, Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 35-1-406, Yamadahigashi 4-chome, Suita-shi, Osaka	CITY Osaka	STATE OR COUNTRY 565-0821 Japan

Full Name of Sixth Inventor	FAMILY NAME ADACHI	FIRST GIVEN NAME Hideto	SECOND GIVEN NAME
Residence & Citizenship	CITY Oakayama-shi	STATE OR COUNTRY Okayama, Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 338-B102, Higashikawahara, Okayama-shi, Okayama	CITY Okayama	STATE OR COUNTRY 703-8255 Japan

Full Name of Seventh Inventor	FAMILY NAME TAMURA	FIRST GIVEN NAME Masatoshi	SECOND GIVEN NAME
Residence & Citizenship	CITY Takatsuki-shi	STATE OR COUNTRY Osaka, Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 2-8, Sachimachi, Takatsuki-shi, Osaka	CITY Osaka	STATE OR COUNTRY 569-1143 Japan

I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

1st Inventor Korekazu Mochida Kyoko Mochida Date November 20, 2003
 Korekazu MOCHIDA and Kyoko MOCHIDA,
 Legal Representatives whose mailing address is
 24-4, Ooiwahon-cho, Shizuoka-shi, Shizuoka 420-0884 JAPAN

2nd Inventor Hiroto Inoue Date November 17, 2003
 Hiroto INOUE

3rd Inventor Suguru Nakao Date Nov. 17, 2003
 Suguru NAKAO

4th Inventor Yukihiro Iwata Date Nov. 17, 2003
 Yukihiro IWATA

5th Inventor Akira Takamori Date Nov. 28, 2003
 Akira TAKAMORI

6th Inventor Hideto Adachi Date Nov. 30, 2003
 Hideto ADACHI

7th Inventor Masatoshi Tamura Date Dec. 3, 2003
 Masatoshi TAMURA

The above application may be more particularly identified as follows:

U.S. Application Serial No. _____ Filing Date _____

Applicant Reference Number 538060 Atty Docket No. _____

Title of Invention A METHOD OF MOUNTING A SEMICONDUCTOR LASER COMPONENT ON A SUBMOUNT